## 2SK3035 (Tentative) <br> Silicon N-Channel Power F-MOS FET

## - Features

- Avalanche energy capacity guaranteed
- High-speed switching
- Low ON-resistance
- No secondary breakdown
- Low-voltage drive
- High electrostatic breakdown voltage


## - Applications

- Contactless relay
- Diving circuit for a solenoid
- Driving circuit for a motor
- Control equipment
- Switching power supply

Absolute Maximum Ratings $\left(\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right)$

| Parameter |  | Symbol | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Drain to Source breakdown voltage |  | $\mathrm{V}_{\text {DSS }}$ | 150 | V |
| Gate to Source voltage |  | $\mathrm{V}_{\text {GSS }}$ | $\pm 20$ | V |
| Drain current | DC | $\mathrm{I}_{\mathrm{D}}$ | $\pm 3$ | A |
|  | Pulse | $\mathrm{I}_{\mathrm{DP}}$ | $\pm 6$ | A |
| Avalanche energy capacity |  | EAS* | 0.45 | mJ |
| Allowable power dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 10 | W |
|  | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 1 |  |
| Channel temperature |  | $\mathrm{T}_{\text {ch }}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature |  | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

* $\mathrm{L}=0.1 \mathrm{mH}, \mathrm{I}_{\mathrm{L}}=3 \mathrm{~A}, 1$ pulse


Internal Connection


Electrical C haracteristics ( $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Conditions | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Drain to Source cut-off current | $\mathrm{I}_{\text {DSS }}$ | $\mathrm{V}_{\mathrm{DS}}=120 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0$ |  |  | 10 | $\mu \mathrm{A}$ |
| Gate to Source leakage current | $\mathrm{I}_{\mathrm{GSS}}$ | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| Drain to Source breakdown voltage | $\mathrm{V}_{\text {DSS }}$ | $\mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{GS}}=0$ | 150 |  |  | V |
| Gate threshold voltage | $\mathrm{V}_{\text {th }}$ | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}$ | 1 |  | 2.5 | V |
| Drain to Source ON-resistance | $\mathrm{R}_{\mathrm{DS} \text { (on)1 }}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=2 \mathrm{~A}$ |  | 0.52 | 1.1 | $\mathrm{m} \Omega$ |
|  | $\mathrm{R}_{\mathrm{DS} \text { (on)2 }}$ | $\mathrm{V}_{\mathrm{GS}}=4 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=2 \mathrm{~A}$ |  | 0.6 | 1.3 | $\mathrm{m} \Omega$ |
| Forward transfer admittance | $\left\|\mathrm{Y}_{\mathrm{fs}}\right\|$ | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=2 \mathrm{~A}$ | 1.5 | 2.7 |  | S |
| Diode forward voltage | $\mathrm{V}_{\text {DSF }}$ | $\mathrm{I}_{\mathrm{DR}}=3 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0$ |  |  | -1.4 | V |
| Input capacitance (Common Source) | $\mathrm{C}_{\mathrm{iss}}$ | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0, \mathrm{f}=1 \mathrm{MHz}$ |  | 190 |  | pF |
| Output capacitance (Common Source) | $\mathrm{C}_{\mathrm{oss}}$ |  |  | 45 |  | pF |
| Reverse transfer capacitance (Common Source) | $\mathrm{C}_{\mathrm{rss}}$ |  |  | 25 |  | pF |
| Turn-on time (delay time) | $\mathrm{t}_{\mathrm{d} \text { (on) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=100 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=2 \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega \end{aligned}$ |  | 13 |  | ns |
| Rise time | $\mathrm{t}_{\mathrm{r}}$ |  |  | 25 |  | ns |
| Fall time | $\mathrm{t}_{\mathrm{f}}$ |  |  | 135 |  | ns |
| Turn-off time (delay time) | $\mathrm{t}_{\mathrm{d}(\mathrm{off})}$ |  |  | 540 |  | ns |
| Thermal resistance between channel and case | $\mathrm{R}_{\mathrm{th}(\mathrm{ch-c})}$ |  |  |  | 12.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal resistance between channel and atmosphere | $\mathrm{R}_{\mathrm{th}(\mathrm{ch-a)}}$ |  |  |  | 125 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

